

Capture, Imagine, Create: Enabling Highly-accurate Desktop 3D Printing and Portable 3D Scanning with New DLP Pico Chipsets



Srik Gurrapu

The desire to differentiate is fundamentally human and is constantly on the rise. Personalization is becoming more and more important in our lives. Texas Instruments DLP® technology is continuously innovating in responding to these demands.

We get excited when we get that cup of coffee with our name personalized on it. People pay premium to have their names imprinted on the clothing that they wear. Now, imagine a ring that you wear with your name imprinted on it. Better yet, imagine a ring that is designed exactly as per your taste that matches with the clothing that you just bought at a store. Imagine a ring that is designed and built by you and not by someone in an unknown factory.

Such are the possibilities that could be realized with the new DLP Pico™ chipsets, which bring industrial performance to small, portable applications. Soon, consumers will be able to take a high-accuracy 3D image of their ring finger and design a ring that fits perfectly, and then use a 3D printer at a nearby store or at home to make the ring. For that matter, they could create multiple rings for multiple occasions – a formal business meeting, a sports game or a family vacation. Several other examples could be imagined, such as the customized phone cases shown in the [Figure 1](#), customized toys, puzzles, home decor and many more – all symbolizing a new wave of “made by me” sense of satisfaction and pride.

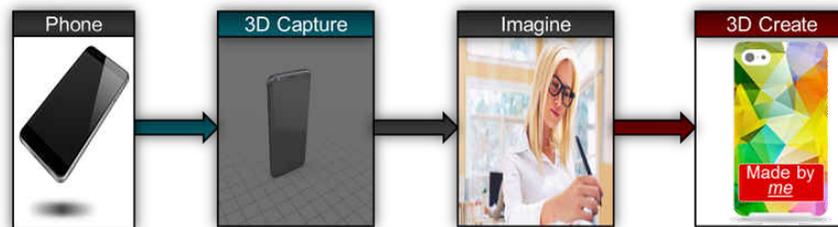


Figure 1. Real world example: Process to customize a smartphone case

The vision of capturing the real world in high-accuracy 3D, imagining new possibilities in 3D and creating real objects in 3D is here now, and is made possible with DLP technology. TI’s DLP technology is already proven in high-performance industrial 3D machine vision and 3D printing applications with its larger DLP DLP4500 and DLP9000 chips. When paired with one of four existing DLP Pico digital micromirror devices (DMDs), the new DLPC3470, DLPC3478 and DLPC3479 controllers create entirely new chipsets that enable a new generation of desktop 3D printers and portable 3D scanners with high-speed and high-resolution capabilities typically found in industrial-grade products. Different uses cases of portable 3D scanning and 3D printing are shown in [Figure 2](#) and [Figure 3](#), respectively.



Figure 2. Sample Portable 3D scanning applications



Figure 3. Different possibilities with 3D printing

The new controllers pair with DLP2010, DLP2010NIR, DLP3010 and DLP4710 DMDs ranging in size from 0.2 to 0.47-inches in diagonal and offer a scalable platform. The DLPC347x controllers are pin-to-pin compatible to existing DLPC343x display controllers and offer several additional features that benefit non-display light control applications that include 3D scanning and 3D printing. The controller and DMD mapping is shown in the table below.

Table 1. New Pico chipsets for 3D printing and 3D scanning

Chipset controller	Chipset DMD	Wavelength	Pixel array	Availability
DLPC3470	DLP2010NIR	700-2500nm	854 x 480	Now
DLPC3470	DLP2010	400-700nm	854 x 480	Now
DLPC3478	DLP3010	400-700nm	1280 x 720	Now
DLPC3479	DLP4710	400-700nm	1920 x 1080	Now

The family of four new chipsets range from small sizes up to larger chips that deliver 1080P resolution. These chipsets enable you to design a range of products from compact, battery-operated scanners and printers to high-performance prosumer products.



Figure 4. DMD and Controller Mapping

The real world around exists in three dimensions, and human eyes are naturally designed to see the world in 3D. With this new technology, you can now design smart scanning devices that can capture any object in 3D with high accuracy and provide a faithful representation in real-time. It is exciting to imagine the new ways of synthesizing this information and bring novel concepts into real-world tangible 3D objects. DLP technology can help you realize endless possibilities in a broad variety of applications across industrial, medical and consumer markets making our lives more efficient and more fun than ever before.

To get started, view the [Small Form-factor Structured Light Pattern Generator Reference Design for Portable 3D Scanners](#).

Additional resources:

- Learn more about 3D scanning and 3D printing at: <http://www.ti.com/dlp-chip/advanced-light-control/applications.html>
- Read the white paper “High accuracy 3D scanning using Texas Instruments DLP® technology for structured light” :
- Check out the [DLP2010 Light Control evaluation module](#) and the [DLP3010 Light Control evaluation module](#).

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2023, Texas Instruments Incorporated